

Docket No.: YOR920040234US1 (17884)

FORM PTO-1595 (Modified)
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P08A/REV03

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Jack O. Chu
Michael A. Cobb
Philip A. Saunders
Leathen Shi

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: International Business Machines CorporationAddress: New Orchard RoadCity: ArmonkState/Prov.: NYCountry: USAZIP: 10504

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ OtherExecution Date: 09/07, 09/02, 09/03, 09/03/2004

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4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is:

Patent Application No.

Filing date

B. Patent No.(s)

10/939,736September 13, 2004

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Steven Fischman, Esq.Registration No. 34,594Address: 400 Garden City PlazaSuite 300City: Garden CityState/Prov.: NYCountry: USAZIP: 11530

6. Total number of applications and patents involved:

17. Total fee (37 CFR 3.41):.....\$ 40.00☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☒ Authorized to be charged to deposit account

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PATENT
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IBM Docket No.: YOR920040234US1
SSMP: 17884

ASSIGNMENT

Whereas, we

Inventor And City	(1) Jack O. Chu County of Nassau	City of Manhasset Hills and State of New York
and	(2) Michael A. Cobb County of Westchester	City of Croton on Hudson and State of New York
and	(3) Philip A. Saunders County of Westchester	City of Millwood and State of New York
and	(4) Leathen Shi County of Westchester	City of Yorktown Heights and State of New York

have invented certain improvements in

Title METHOD OF CREATING DEFECT FREE HIGH Ge CONTENT (>25%) SiGe-ON-INSULATOR
(SGOI) SUBSTRATES USING WAFER BONDING TECHNIQUES

Dates That
Inventors
Signed the
Declaration and have executed, respectively, a United States patent application therefor on
(1) *Jack O. Chu* 9-7-04 2004, and (2) *Michael A. Cobb* 9/2/2004, and
(3) *Philip A. Saunders* 09-03-2004, and (4) *Leathen Shi* 9/3/2004.

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

IBM Docket No.: YOR920040234US1
SSMP: 17884

ASSIGNMENT

City	(1) Signed at	YorKtown Heights, NY		signature
Date	on	9-07-04	(Jack O. Chu) inventor	
			First Name Middle Initial Last Name	
City	(2) Signed at	YORKTOWN HEIGHTS, NY		signature
Date	on	Sept 2, 2004	(Michael A. Cobb) inventor	
			First Name Middle Initial Last Name	
City	(3) Signed at	YORKTOWN HEIGHTS, NY		signature
Date	on	09-03-04	(Philip A. Saunders) inventor	
			First Name Middle Initial Last Name	
City	(4) Signed at	Yorktown Heights, NY		signature
Date	on	Sept. 3, 2004	(Leathan Shi) inventor	
			First Name Middle Initial Last Name	